Berry IO Board Schematics Document

Arrandale

Intel PCH

2010-02-04

REV: A00

DY : Nopop Component

WWAN : Pop for WWAN

TP : Pop for Touch Panel

Wistron Corporation
21F, 88, Sec. 1, Hsin Tai Wu Rd., Hsichih,
Taipei Hsien 221, Taiwan, R.O.C.

Title

Cover Page

Size
A3

Document Number
A3

Berry IO Board
A00

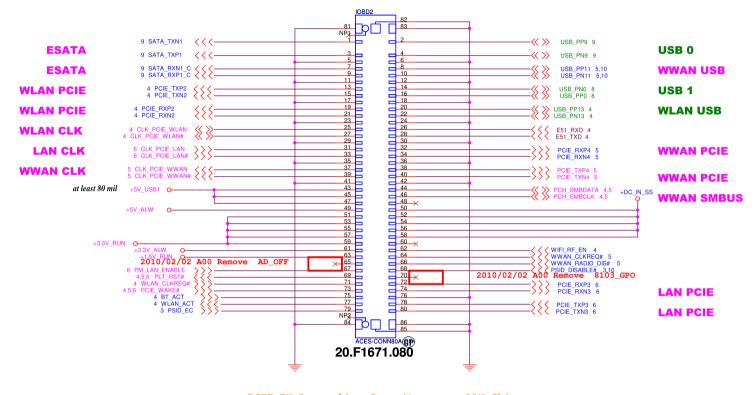
Date: Thursday, February 04, 2010
Sheet 1 of 12

Berry IO Board

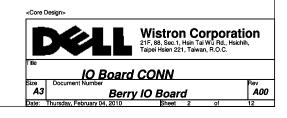
Project code:91.4HH01.001

PCB P/N :09697-1

REVISION :-1

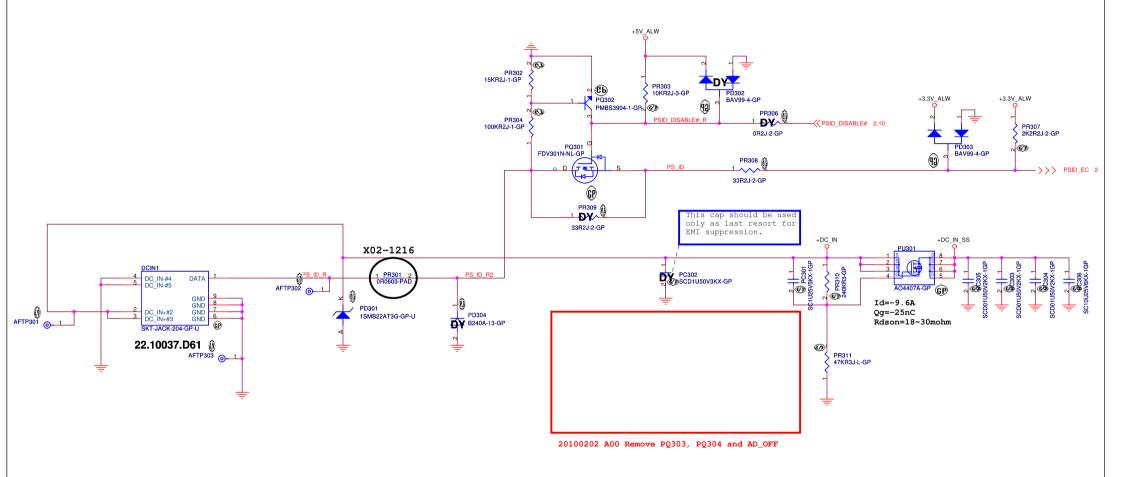


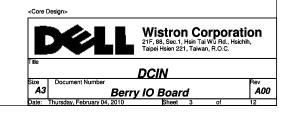
PCIE_RX Decoupling Capacitor near LAN Chip



SSID = PWR.Support

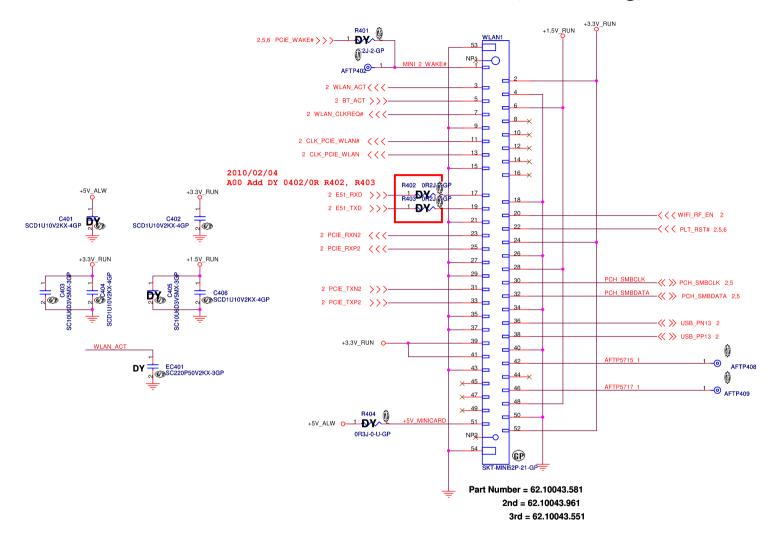
DCin CONN

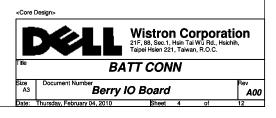


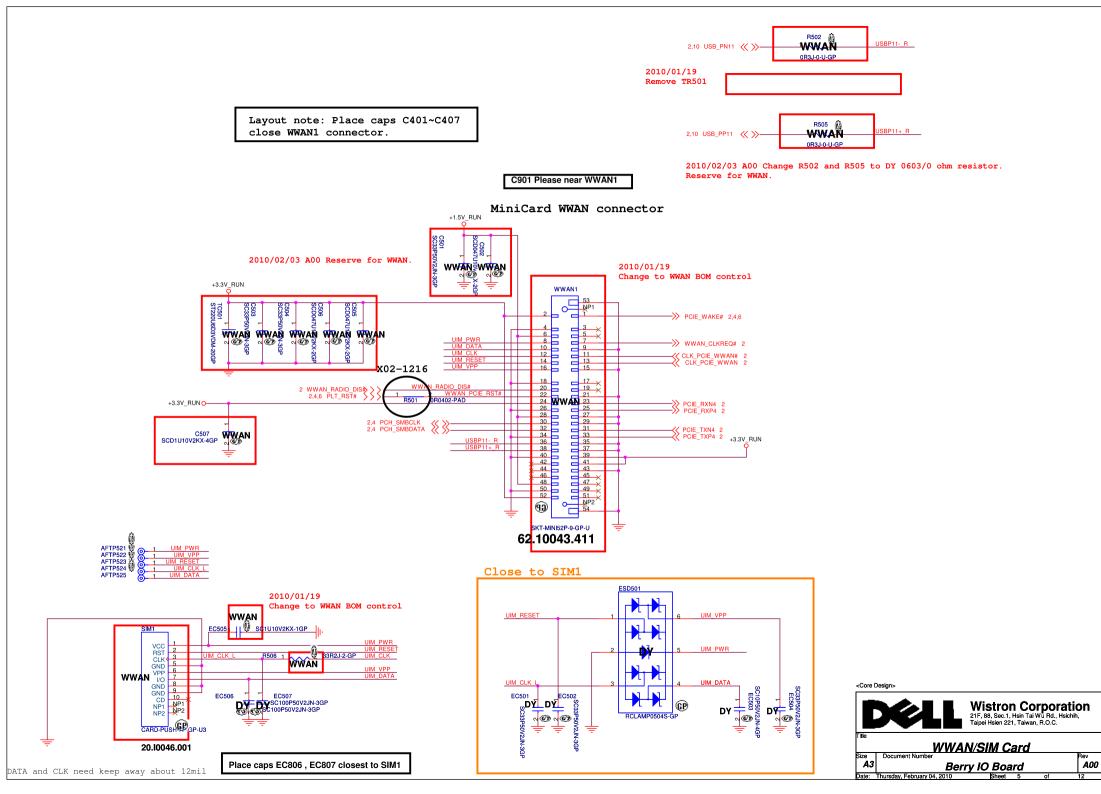


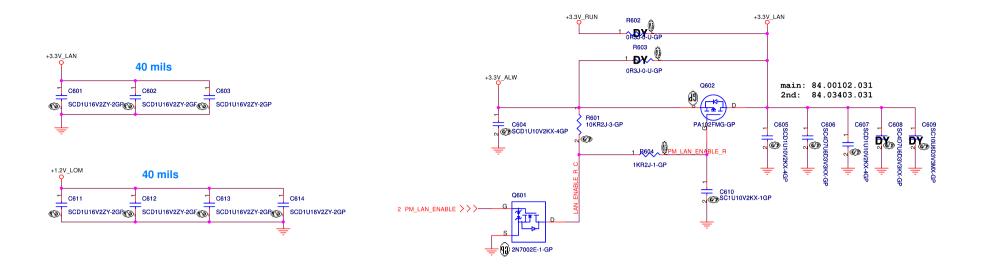
SSID = Wireless

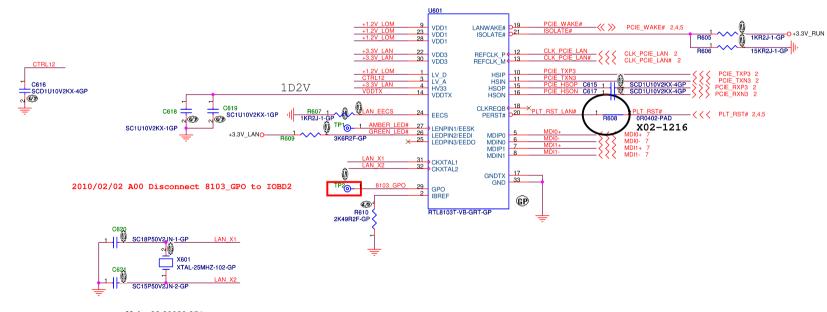
Mini Card Connector(802.11a/b/g)



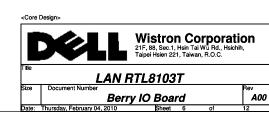


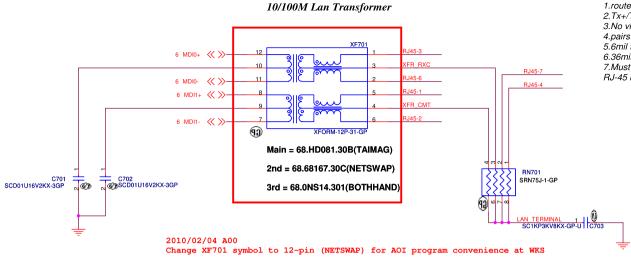






Main: 82.30020.851 2nd: 82.30020.791

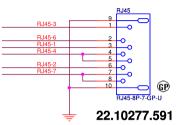




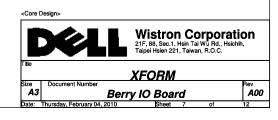
1.route on bottom as differential pairs.

- 2.Tx+/Tx- are pairs. Rx+/Rx- are pairs.
- 3.No vias, No 90 degree bends. 4.pairs must be equal lengths.
- 5.6mil trace width, 12mil separation.
- 6.36mil between pairs and any other trace. 7.Must not cross ground moat, except
- RJ-45 moat.

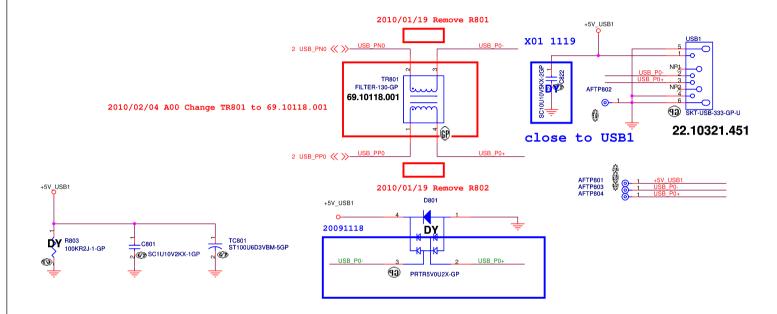
RJ45 Connector

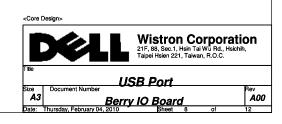




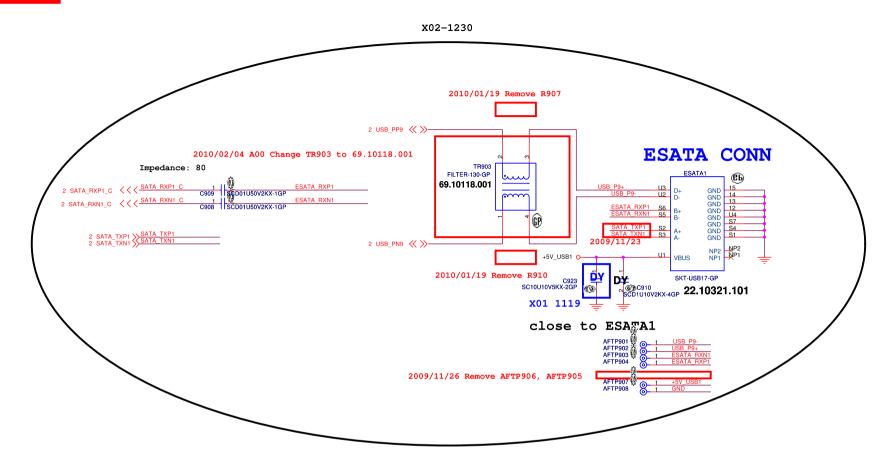


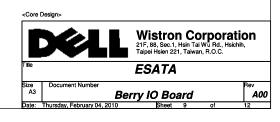
SSID = USB

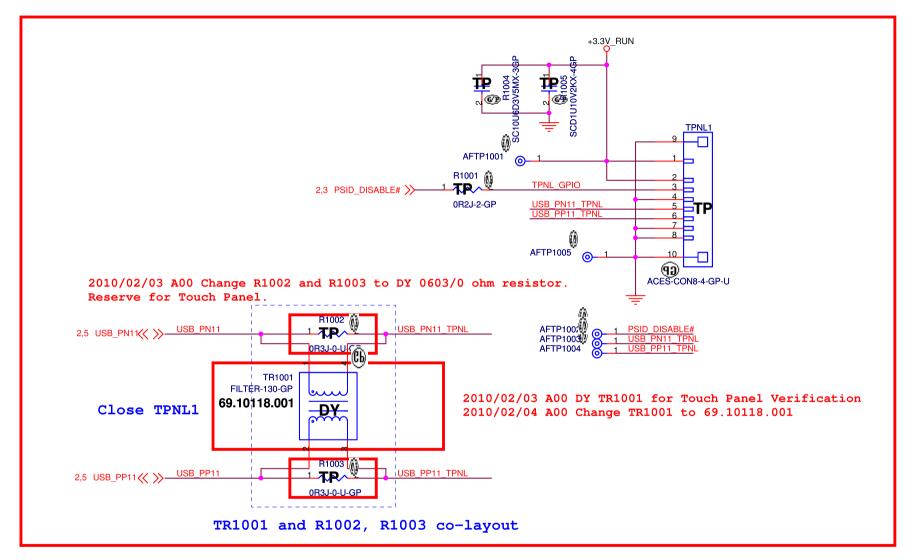


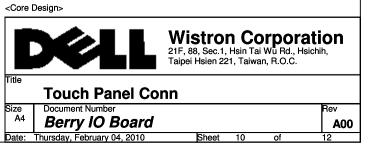


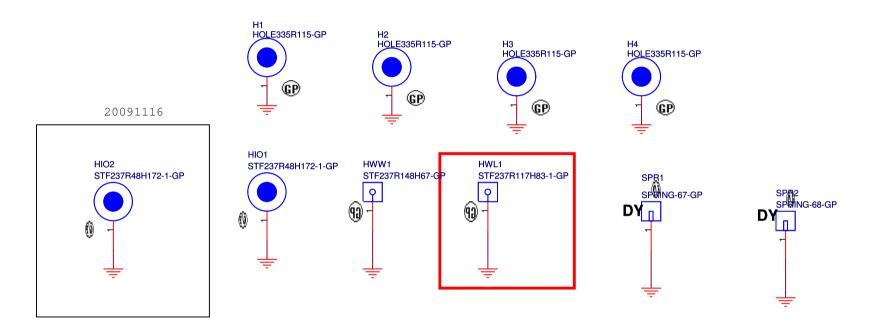
SSID = ESATA











20100202 A00 Change the HWL1 standoff from 34.4W005.001 to 34.4CK01.001

<Core Design>



